



## Material declaration form

General Information			
IPC	1752	Version	2
Form type*	Distribute		
Sectionals*	Material information	Subsectionals*	A-D
	Manufacturing information		*: Required Field

Supplier Information			
Company name*	STMicroelectronics	Response Date*	2024-10-03
Contact name*	Refer to Supplier Comment section		Refer to Supplier Comment section
Contact phone*	Refer to Supplier Comment section	Contact email*	Refer to Supplier Comment section
Authorized representative*	Floriana SAN BIAGIO	Representative title	APMS Material Declaration champion
Representative phone*	Refer to Supplier Comment section	Representative email*	Refer to Supplier Comment section
Supplier comment	Online Technical Support - STMicroelectronics : <a href="http://www.st.com/web/en/support/support.html">http://www.st.com/web/en/support/support.html</a>		

**Uncertainty statement**

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**Legal statement**

Supplier acceptance*	true	Legal declaration*	Standard
Supplier certifies that it gathered the provided information and such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part(s), and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part(s), the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form.			



Product				
Mfr item number	Mfr item name	Version	Manufacturing site	date
	9JY7*MY3KADA	A	994D	2024-10-03
	Amount	Unit of measure	Unit type	ST ECOPACK grade
	400	mg	Each	ECOPACK® 3
<b>Identity</b>	<b>Authority</b>			
Comment	ECOPACK® 3 is STMicroelectronics trade name for ROHS compliant device without use of any ROHS exemption and without Halogen nor Antimony			

Manufacturing information			
J-STD-020 MSL rating	Classification temperature	Number of reflow cycles	
3	260	3	
Bulk solder termination	Terminal plating	Terminal base alloy	Comment
Not Applicable	Tin (Sn), matte, annealed	Copper Alloy	0

Package designator	Package size	Number of instances	Shape	
DSO	10.38x7.55	16	Gull wing	
Comment				
Comment	Y7 SO 16 .30 LARGE JEDEC MS-013; MDF is valid for STGAP3SXSTR-STGAP3SXS			

QueryList : RoHS Directive 2011/65/EU- 8 June 2011 – Annex II amended by Delegated Directive 2015/863 - 31 March 2015		Response
1 - Product(s) meets EU RoHS requirement without any exemptions		true
2 - Product(s) meets EU RoHS requirements except lead in solder and this usage may qualify under the lead in solder '7b' exemption (other selected exemptions may apply)		false
3 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
4 - Product(s) does not meet EU RoHS requirements and is not under exemptions		false
Exemption Id.	Description	

QueryList : ELV directive : 2000/53/EC amended 2020/363_March 2020		Response
1 - Product(s) meets EU ELV requirements without any exemptions		true
2 - Product(s) meets EU RoHS requirements by application of the selected exemption(s)		false
Exemption Id.	Description	

QueryList : California Prop65 list, dated 17th Nov 2023				Response
1 - The product does not contain identified substance from California Prop 65 List, no exposure to consumers is foreseen				false
2 - The product is containing below substance(s) from California Prop 65 List, no exposure to consumers is foreseen				true
Substance	amount in product (mg)	Application	ppm in product	
Nickel	0.013	alloy	33	

QueryList :Customer		Response
QUERY		Response

QueryList : Chinese RoHS , references : SJT 11364 – 2014 and GBT 26572 – 2014					Response
QUERY					Response
1 - Product(s) requires marking for the presence of restricted substances and must be marked with an Environmental Protection Use Period under China's Measures for Administration of the control of pollution by Electronic Information Products					false
2 - Product(s) is eligible for marking with the e code under China's Measures for Administration of the control of pollution by Electronic Information Products					false
Hazardous substance					
Lead (Pb)	Cadmium (Cd)	Mercury (Hg)	Hexavalent Chromium (Cr VI)	PBB & PBDE	
O	O	O	O	O	

QueryList : REACH-27th June 2024				Response
1 - Product(s) does not contain REACH Substances Of Very High Concern above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	amount in product (mg)	Application	ppm in product
2 - Product(s) does not contain REACH Substances Of Very High Concern in any Embedded article nor Homogeneous Material above the limits per the definition within REACH				true
CategoryLevel_Name	CategoryLevel_Threshold	Amount in embedded article / Homogeneous material (mg)	Application - article / Homogeneous material	ppm in article /Homogeneous material



QueryList : Responsible metals sourcing	Response
The component is containing at least one of the following metals : Cobalt , Gold , Tantalum , Tin , Tungsten.	true
The following metals are present is the component :	<b>Gold, Tantalum, Tin, Tungsten,</b>

QueryList : Korea Chemical Control Act_ 27 Dec 2017 update	Response
The Product does contain at least one of the substances listed in Chemical Control Act	false

QueryList : China GB 33372-2020 Limit standard for volatile organic compounds content in adhesives - 4 March 2020 application date 1st December 2020	Response
The product contains adhesives identified under GB 33372	false

QueryList:Stockholm Convention Persistent Organic Pollutants (POP)	Response
Product is compliant with Annex A, B and C of Stockholm Convention Persistent Organic Pollutants	true

QueryList: EU Ship Recycling Regulation No. 1257/2013	Response
Product contains hazardous materials listed in Annex II of EU Ship Recycling Regulation No.1257/2013 and 2009/16/EC Directive	False

PFAS/PTFE Declaration	Response
The product is containing at least one of the following PFAS substance: Polytetrafluoroethylene,Thiophenium, Triphenylsulfonium nonaflate, Trifluoroacetic anhydride	False

BPA Declaration	Response
Product does not contain Bisphenol A (Isopropylidenediphenol)	True

Montreal Protocol	Response
Product does not contain Ozone Depleting Substances based on Annex I to Annex VII of EU REGULATION (EC) No 1005/2009	True

Environmental Protection Agency:Toxic Substances Control Act (TSCA). Section 6(h)	Response
Product does not contain Phenol, isopropylated, phosphate (3:1)	True

Material Composition Declaration : note : Substance present with less 0.001mg will not be declared in this document						Mfr Item Name	9JY7*MY3KADA		398.2785		6937201.0	995704.0				
Homogeneous material	Material group	Mass	Unit of measure	Level	Substance category	Substance	CAS	Exempt	Mass	Unit of measure	Concentration in homogeneous material (ppm)	Concentration in product (ppm)				
Dies	M-011 Other inorganic materials	3.867	mg	supplier	die	Silicon(Si)	7440-21-3		3.527	mg	912077	8818				
				supplier	metallisation	Aluminium(Al)	7429-90-5		0.014	mg	3620	35				
				supplier	metallisation	Copper(Cu)	7440-50-8		0.192	mg	49651	480				
				supplier	metallisation	Nickel(Ni)	7440-02-0		0.013	mg	3362	33				
				supplier	metallisation	Palladium(Pd)	7440-05-3		0.000	mg	0	0				
				supplier	metallisation	Tungsten(W)	7440-33-7		0.019	mg	4913	48				
				supplier	passivation	Silicon oxide	7631-86-9		0.064	mg	16550	160				
				supplier	polymer coating	polyimide	proprietary		0.000	mg	0	0				
				supplier	alloy	Copper(Cu)	7440-50-8		41.384	mg	938924	103460				
				Leadframe	M-004 Copper and its alloys	44.076	mg	supplier	alloy	Iron (Fe)	7439-89-6		1.021	mg	23165	2553
supplier	alloy	Phosphorus(P)	7723-14-0						0.043	mg	976	108				
supplier	alloy	Zinc(Zn)	7440-66-6						0.085	mg	1928	213				
supplier	metallization	Nickel (Ni)	7440-02-0						0.000	mg	0	0				
supplier	metallization	Palladium (Pd)	7440-05-3						0.000	mg	0	0				
supplier	metallization	Gold (Au)	7440-57-5						0.000	mg	0	0				
Die attach	M-015 Other organic materials	0.334	mg					supplier	glue	Silver(Ag)	7440-22-4		0.256	mg	766467	640
								supplier	glue	Bisphenol A Diacrylate	Proprietary		0.027	mg	80838	68
								supplier	glue	Dicyclopentenyl group containing Acrylate	Proprietary		0.017	mg	50898	43
								supplier	glue	Butadiene copolymer	Proprietary		0.003	mg	8982	8
				supplier	glue	Polybutadiene epoxidized derivative	Proprietary		0.018	mg	53892	45				
				supplier	glue	Cresol Novolac Epoxy Resins	29690-82-2		0.007	mg	20958	18				
				supplier	solder	0	0		0.000	mg	0	0				
				supplier	solder	0	0		0.000	mg	0	0				
				supplier	solder	0	0		0.000	mg	0	0				
				supplier	solder	0	0		0.000	mg	0	0				
Bonding wires	M-008 Precious metals	0.085	mg	supplier	wire	Gold (Au)	7440-57-5		0.085	mg	1000000	213				
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
Bonding wires 2	M-004 Copper and its alloys	0.159	mg	supplier	wire	Copper (Cu)	7440-50-8		0.156	mg	981132	390				
				0	supplier	wire	Palladium(Pd)	7440-05-3		0.003	mg	18868	8			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
Bonding wires 3	0	0.000	mg	supplier	wire	0	0		0.000	mg	0	0				
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
				0	supplier	wire	0	0		0.000	mg	0	0			
Bonding Ribbons		0.000	mg	supplier	ribbon	0	0		0.000	mg	0	0				
				supplier	ribbon	0	0		0.000	mg	0	0				
				supplier	ribbon	0	0		0.000	mg	0	0				
Underfill	M-015 Other organic materials	0.000	mg	supplier	resin	0	0		0.000	mg	0	0				
				supplier	resin	0	0		0.000	mg	0	0				
				supplier	resin	0	0		0.000	mg	0	0				
				supplier	resin	0	0		0.000	mg	0	0				
				supplier	resin	0	0		0.000	mg	0	0				



